

#### NPN EPITAXIAL PLANAR TYPE

#### DESCRIPTION

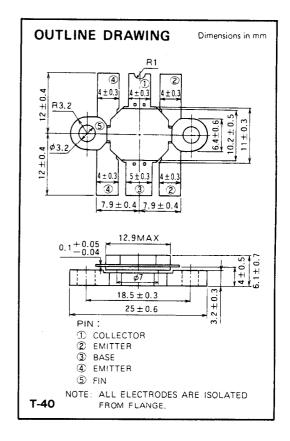
2SC2630 is a silicon NPN epitaxial planar type transistor designed for RF power amplifiers in VHF band mobile radio applications.

#### **FEATURES**

- High power gain:  $G_{pe} \ge 7dB$  $@V_{CC} = 12.5V, P_0 = 50W, f = 175MHz$
- Emitter ballasted construction and gold metallization for high reliability and good performances.
- Low thermal resistance ceramic package with flange.
- Ability of withstanding more than 20:1 load VSWR when operated at V<sub>CC</sub> = 15.2V, P<sub>O</sub> = 50W, f = 175MHz, T<sub>C</sub> = 25°C.
- Equivalent input/output series impedance:  $Z_{in} = 0.8 + j1.2\Omega \text{ @P}_{O} = 60\text{W}, \text{V}_{CC} = 12.5\text{V}, \text{f} = 175\text{MHz}$   $Z_{OUT} = 1.5 j0.6\Omega$

## **APPLICATION**

40 to 60 watts output power amplifiers in VHF band mobile radio applications.



#### ABSOLUTE MAXIMUM RATINGS (To = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Conditions Ratings	
V <sub>CBO</sub>	Collector to base voltage		35	V
VEBO	Emitter to base voltage		4	V
V <sub>CEO</sub>	Collector to emitter voltage	R <sub>BE</sub> = ∞	17	V
1c	Collector current		14	Α
Pc	Collector dissipation	Ta = 25°C	5.5	14/
		T <sub>C</sub> = 25°C	100	w
Tj	Junction temperature		175	°C
Tstg	Storage temperature		-55 to 175	°C
Rth-a	Thereselections	Junction to ambient	27.2	°C/W
Rth-c	Thermal resistance	Junction to case	1.5	°C/W

Note. Above parameters are guaranteed independently.

# **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise specified)

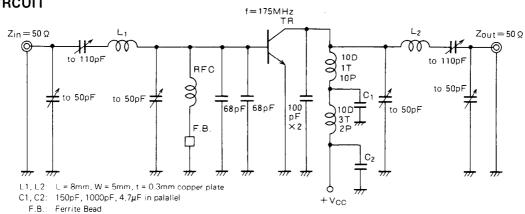
Symbol	Parameter	Test conditions	Limits			11. 1
			Min	Тур	Max	Unit
V(BR)EBO	Emitter to base breakdown voltage	I <sub>E</sub> = 10mA, I <sub>C</sub> = 0	4			V
V(BR)CBO	Collector to base breakdown voltage	I <sub>C</sub> =10mA, I <sub>E</sub> =0	35			V
V(BR)CEO	Collector to emitter breakdown voltage	I <sub>C</sub> = 0.1A, R <sub>BE</sub> = ∞	17			V
СВО	Collector cutoff current	V <sub>CB</sub> =15V, I <sub>E</sub> =0			5	mΑ
I <sub>EBO</sub>	Emitter cutoff current	V <sub>EB</sub> = 3V, I <sub>C</sub> = 0			5	mA
hFE	DC forward current gain *	V <sub>CE</sub> = 10 V, I <sub>C</sub> = 0.2 A	10	40	180	_
Po	Output power	V <sub>CC</sub> = 12.5V, P <sub>IN</sub> = 10W, f = 175MHz	50	60		w
$\eta_{C}$	Collector efficiency		60	70		%

Note. \*Pulse test,  $P_W = 150 \mu s$ , duty=5%.

Above parameters, ratings, limits and conditions are subject to change



#### **TEST CIRCUIT**



COLLECTOR CURRENT Ic (A)

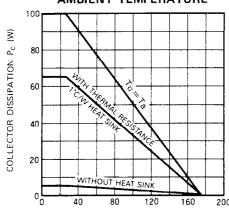
NOTES: All coils are made from 1.5mm p silver plated copper wire

D: Inner diameter of coil Turn number of coil P : Pitch of coil

Dimension in milli-meter

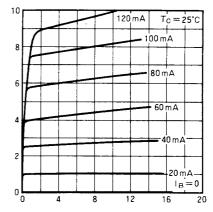
# TYPICAL PERFORMANCE DATA

### COLLECTOR DISSIPATION VS. AMBIENT TEMPERATURE



AMBIENT TEMPERATURE Ta (°C)

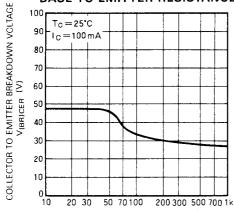
## COLLECTOR CURRENT VS. **COLLECTOR TO EMITTER VOLTAGE**



COLLECTOR TO EMITTER VOLTAGE VCE (V)

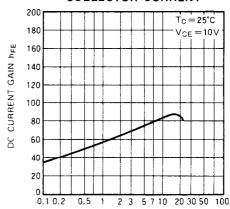
## **COLLECTOR TO EMITTER BREAKDOWN VOLTAGE VS.**

BASE TO EMITTER RESISTANCE



BASE TO EMITTER RESISTANCE RBE (Q)

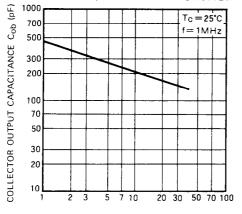
### DC CURRENT GAIN VS. **COLLECTOR CURRENT**



COLLECTOR CURRENT Ic (A)

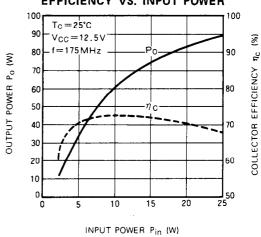
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# COLLECTOR OUTPUT CAPACITANCE VS. COLLECTOR TO BASE VOLTAGE

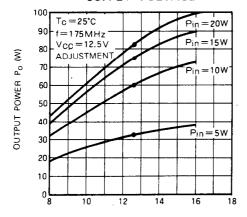


COLLECTOR TO BASE VOLTAGE VCB (V)

# OUTPUT POWER, COLLECTOR EFFICIENCY VS. INPUT POWER



# OUTPUT POWER VS. COLLECTOR SUPPLY VOLTAGE



COLLECTOR SUPPLY VOLTAGE VCC (V)